

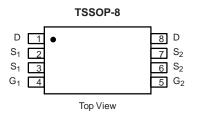
# Dual N-Channel 30-V (D-S) MOSFET

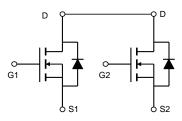
PRODUCT SUMMARY				
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A)		
30	0.012 at $V_{GS}$ = 10 V	8.6		
	0.019 at V <sub>GS</sub> = 4.5 V	7.5		

### **FEATURES**

- Halogen-free Option Available
- TrenchFET<sup>®</sup> Power MOSFETs







ABSOLUTE MAXIMUM RATINGS T	$A = 25 ^{\circ}C$ , unles	s otherwise n	oted		
Parameter		Symbol	10 s	Steady State	Unit
Drain-Source Voltage		V <sub>DS</sub>	30		V
Gate-Source Voltage		V <sub>GS</sub>	± 20		v
Continuous Drain Current /T 150 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	8.6	7.2	•
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>a</sup>	T <sub>A</sub> = 70 °C		7.5	5.5	
Pulsed Drain Current		I <sub>DM</sub>	30		A
Continuous Source Current (Diode Conduction) <sup>a</sup>		۱ <sub>S</sub>	1.5	1.0	
Mariana Diata di a	T <sub>A</sub> = 25 °C	- P <sub>D</sub>	1.6	1.2	w
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 70 °C		0.98	0.67	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 t	to 150	°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Тур.	Max.	Unit
Maximum has the to Asthingta	t ≤ 10 s	R <sub>thJA</sub>	72	83	
Maximum Junction-to-Ambient <sup>a</sup>	Steady State		100	120	°C/W
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	55	70	

Notes:

a. Surface Mounted on FR4 board,  $t \leq 10 \mbox{ s.}$ 

\* Pb containing terminations are not RoHS compliant, exemptions may apply.

Parameter	Symbol	Test Conditions	Min.	Typ. <sup>a</sup>	Max.	Unit	
Static	μ						
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	1.5		3.0	V	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 10 V$			± 200	nA	
	I <sub>DSS</sub>	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70 ^{\circ}\text{C}$	25			μA	
On-State Drain Current <sup>b</sup>	I <sub>D(on)</sub>	$V_{DS}{\leq}5$ V, $V_{GS}{=}4.5$ V	30			А	
Drain-Source On-State Resistance <sup>b</sup>		$V_{GS} = 10 \text{ V}$ , $I_{D} = 8.5 \text{ A}$		0.012		Ω	
	R <sub>DS(on)</sub>	$V_{GS}$ = 4.5 V, I <sub>D</sub> = 7.5 A		0.019			
Forward Transconductance <sup>b</sup>	9 <sub>fs</sub>	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 6.5 \text{ A}$		30		S	
Diode Forward Voltage <sup>b</sup>	V <sub>SD</sub>	$I_{S} = 1.5 \text{ A}, V_{GS} = 0 \text{ V}$		0.71	1.2	V	
Dynamic <sup>a</sup>							
Total Gate Charge	Qg			13		nC	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ = 15 V, $V_{GS}$ = 4.5 V, $I_{D}$ = 6.5 A		2.2			
Gate-Drain Charge	Q <sub>gd</sub>			3.6			
Turn-On Delay Time	t <sub>d(on)</sub>			245	365		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15V , $R_L$ = 10 $\Omega$		330	495	ns	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong$ 1 A, $V_{GEN}$ = 4.5 V, $R_G$ = 6 $\Omega$		860	1300		
Fall Time	t <sub>f</sub>			510	765		

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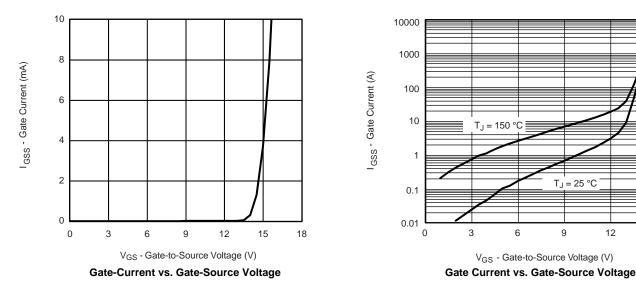
Notes:

a. For design aid only; not subject to production testing.

b. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

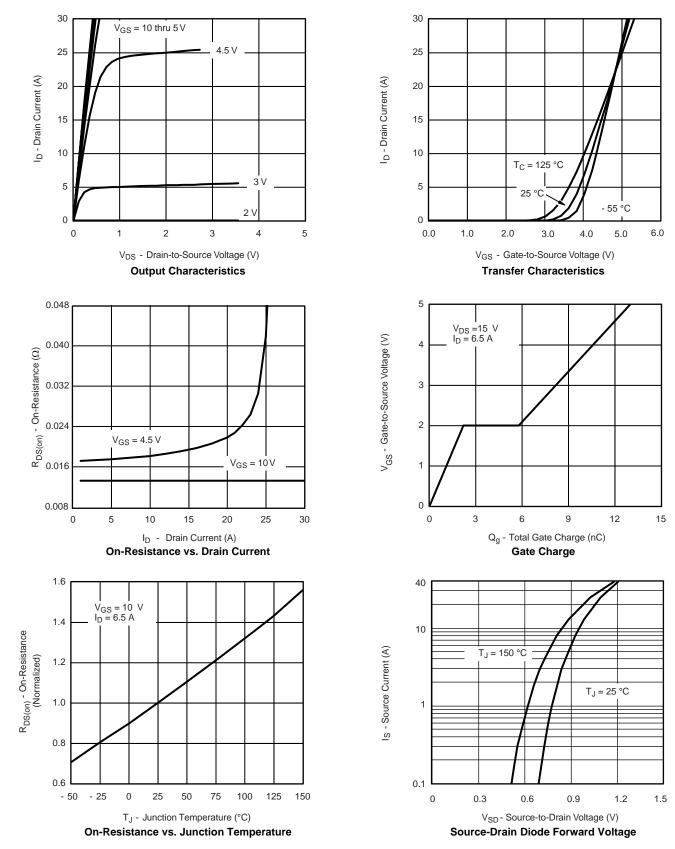
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

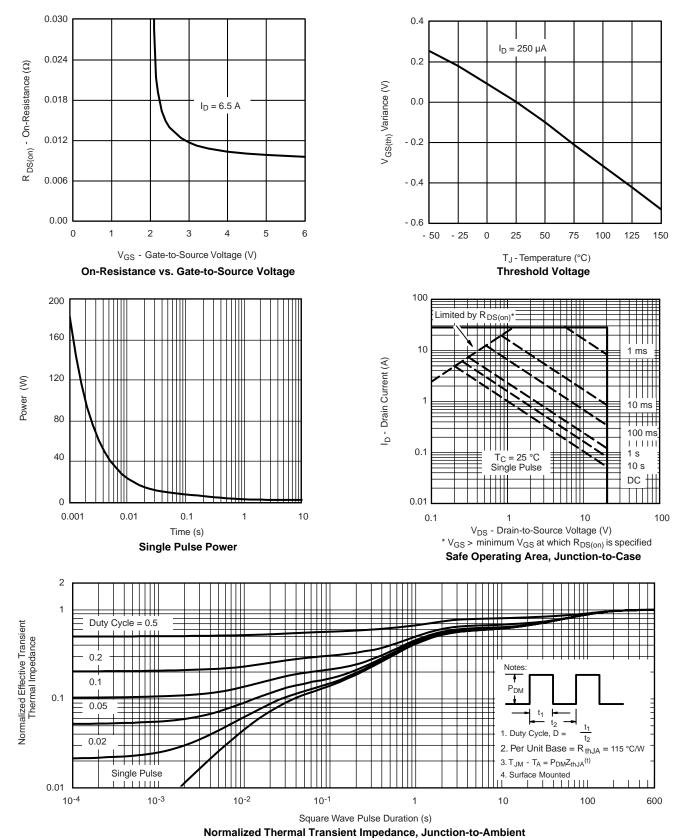








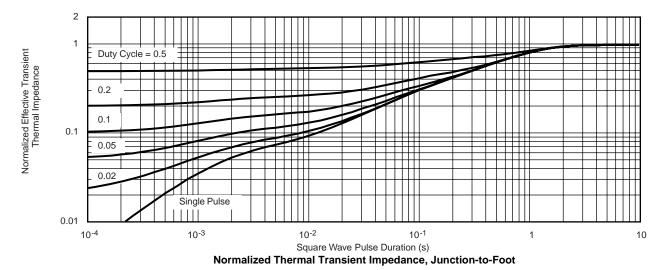




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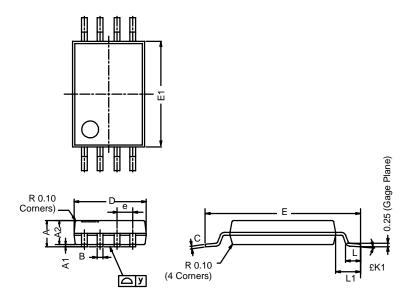


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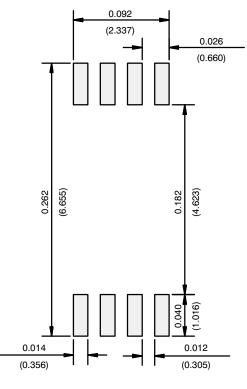
TSSOP: 8-LEAD JEDEC Part Number: MO-153



	MILLIMETERS				
Dim	Min	Nom M			
Α	-	-	1.20		
<b>A</b> <sub>1</sub>	0.05	0.10	0.15		
A <sub>2</sub>	0.80	1.00	1.05		
В	0.19	0.28	0.30		
С	-	0.127	-		
D	2.90	3.00	3.10		
Е	6.20	6.40	6.60		
E <sub>1</sub>	4.30	4.40	4.50		
е	-	0.65	-		
L	0.45	0.60	0.75		
L <sub>1</sub>	0.90	1.00	1.10		
Y	-	-	0.10		
£ <b>K1</b>	0°	3°	6°		
ECN: S-03946—Rev. G, 09-Jul-01 DWG: 5844					



## **RECOMMENDED MINIMUM PADS FOR TSSOP-8**



Recommended Minimum Pads Dimensions in Inches/(mm)



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